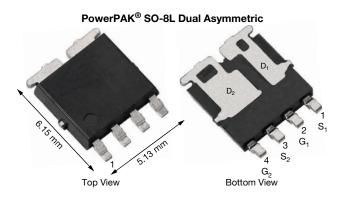


Vishay Siliconix

## Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFETs



| PRODUCT SUMMARY                                  |                           |             |  |  |  |  |  |
|--|---------------------------|-------------|--|--|--|--|--|
|  | N-CHANNEL 1               | N-CHANNEL 2 |  |  |  |  |  |
| V <sub>DS</sub> (V)                              | 40                        | 40          |  |  |  |  |  |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$  | 0.00940                   | 0.00390     |  |  |  |  |  |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$ | 0.01173                   | 0.00480     |  |  |  |  |  |
| I <sub>D</sub> (A)                               | 20                        | 60          |  |  |  |  |  |
| Configuration                                    | Dual                      |             |  |  |  |  |  |
| Package  | PowerPAK SO-8L asymmetric |             |  |  |  |  |  |

### **FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- · Optimized for synchronous buck applications
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

| D <sub>1</sub>     | D <sub>2</sub>     |
|--------------------|--------------------|
| G,                 | $G_2$              |
| J                  | J                  |
| S <sub>1</sub>     | S <sub>2</sub>     |
| N-Channel 1 MOSFET | N-Channel 2 MOSFET |

| ABSOLUTE MAXIMUM RATINGS $(T_C$                   | = 25 °C, unless         | otherwise r                       | noted)          |                 |    |
|---|-------------------------|-----------------------------------|-----------------|-----------------|----|
| PARAMETER   | SYMBOL                  | N-CHANNEL 1                       | N-CHANNEL 2     | UNIT            |    |
| Drain-source voltage                              |                         | $V_{DS}$                          | 40              | 40              | V  |
| Gate-source voltage                               | V <sub>GS</sub>         | ± 20                              |                 | V               |    |
| Continuous drain current                          | T <sub>C</sub> = 25 °C  |                                   | 20 a            | 60 <sup>a</sup> |    |
| Continuous drain current                          | T <sub>C</sub> = 125 °C | I <sub>D</sub>                    | 20 a            | 46              |    |
| Continuous source current (diode conduction)      | •                       | I <sub>S</sub>                    | 20 <sup>a</sup> | 44              | Α  |
| Pulsed drain current <sup>b</sup>                 |                         | I <sub>DM</sub>                   | 80              | 220             |    |
| Single pulse avalanche current                    | L = 0.1 mH              | I <sub>AS</sub>                   | 18              | 29              |    |
| Single pulse avalanche energy                     | L = U. I MH             | E <sub>AS</sub>                   | 16              | 42              | mJ |
| Maximum power dissipation <sup>b</sup>            | T <sub>C</sub> = 25 °C  | Б                                 | 27              | 48              | W  |
| Maximum power dissipation 5                       | T <sub>C</sub> = 125 °C | $P_{D}$                           | 9               | 16              | VV |
| Operating junction and storage temperature range  |                         | T <sub>J</sub> , T <sub>stg</sub> | -55 to +175     |                 | °C |
| Soldering recommendations (peak temperature) d, e |                         | 2                                 | 60              | C               |    |

| THERMAL RESISTANCE RATINGS |                        |            |             |             |      |
|----------------------------|------------------------|------------|-------------|-------------|------|
| PARAMETER                  |                        | SYMBOL     | N-CHANNEL 1 | N-CHANNEL 2 | UNIT |
| Junction-to-ambient        | PCB mount <sup>c</sup> | $R_{thJA}$ | 85          | 85          | °C/W |
| Junction-to-case (drain)   |                        | $R_{thJC}$ | 5.5         | 3.1         | C/VV |

#### Notes

- a. Package limited
- b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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| PARAMETER  | SYMBOL              |                         | TEST CONDITIONS                                   | MIN.   | TYP. | MAX.    | UNIT    |     |  |
|--|---------------------|-------------------------|---|--------|------|---------|---------|-----|--|
| Static   |                     |                         |   |        |      |         | l .     |     |  |
| Duain a compa la made de como colta de   |                     | V <sub>GS</sub> =       | N-Ch 1  | 40     | -    | -       |         |     |  |
| Drain-source breakdown voltage   | $V_{DS}$            | V <sub>GS</sub> =       | N-Ch2   | 40     | -    | -       | V       |     |  |
| Cata accuracy thready ald violage  |                     | V <sub>DS</sub> =       | N-Ch 1  | 1.3    | 1.8  | 2.3     |         |     |  |
| Gate-source threshold voltage  | V <sub>GS(th)</sub> | V <sub>DS</sub> =       | N-Ch 2  | 1.4    | 1.9  | 2.4     |         |     |  |
| Cata aguraa laakaga  |                     | V/ -                    | 0.777 - + 20.77                                   | N-Ch 1 | -    | -       | ± 100   | A   |  |
| Gate-source leakage  | I <sub>GSS</sub>    | v <sub>DS</sub> =       | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ |        | -    | -       | ± 100   | nA  |  |
|  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 40 V                            | N-Ch 1 | -    | -       | 1       |     |  |
|  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 40 V                            | N-Ch2  | -    | -       | 1       |     |  |
| Zava gata valtaga duain avuvant  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C   | N-Ch 1 | -    | -       | 50      |     |  |
| Zero gate voltage drain current  | I <sub>DSS</sub>    | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C   | N-Ch2  | -    | -       | 50      | μΑ  |  |
|  |                     | $V_{GS} = 0 V$          | V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C   | N-Ch 1 | -    | -       | 250     |     |  |
|  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C   | N-Ch2  | -    | -       | 300     |     |  |
|  |                     | V <sub>GS</sub> = 10 V  | $V_{DS} \ge 5 \text{ V}$                          | N-Ch 1 | 10   | -       | -       | А   |  |
| On-state drain current <sup>a</sup>  | I <sub>D(on)</sub>  | V <sub>GS</sub> = 10 V  | $V_{DS} \ge 5 \text{ V}$                          | N-Ch2  | 20   | -       | -       |     |  |
|  |                     | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 6 A                              | N-Ch 1 | -    | 0.00770 | 0.00940 | Ω   |  |
|  |                     | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 10 A                             | N-Ch2  | -    | 0.00320 | 0.00390 |     |  |
|  | R <sub>DS(on)</sub> | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 6 A, T <sub>J</sub> = 125 °C     | N-Ch 1 | -    | -       | 0.01370 |     |  |
| Duta a su a su a la la contacta de l |                     | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C    | N-Ch2  | -    | -       | 0.00570 |     |  |
| Drain-source on-state resistance <sup>a</sup>  |                     | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 6 A, T <sub>J</sub> = 175 °C     | N-Ch 1 | -    | -       | 0.01600 |     |  |
|  |                     | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C    | N-Ch2  | -    | -       | 0.00670 |     |  |
|  |                     | V <sub>GS</sub> = 4.5 V | I <sub>D</sub> = 4 A                              | N-Ch 1 | -    | 0.00970 | 0.01173 |     |  |
|  |                     | V <sub>GS</sub> = 4.5 V | I <sub>D</sub> = 8 A                              | N-Ch2  | -    | 0.00400 | 0.00480 |     |  |
| Face and the control of the control  |                     | V <sub>DS</sub>         | = 15 V, I <sub>D</sub> = 6 A                      | N-Ch 1 | -    | 32      | -       | - S |  |
| Forward transconductance b   | 9 <sub>fs</sub>     | V <sub>DS</sub>         | = 15 V, I <sub>D</sub> = 10 A                     | N-Ch2  | -    | 51      | -       |     |  |
| Dynamic <sup>b</sup>   |                     |                         |   |        |      | •       |         |     |  |
| Teachers and the second  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 25 V, f = 1 MHz                 | N-Ch 1 | -    | 1197    | 1700    |     |  |
| Input capacitance  | C <sub>iss</sub>    | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 25 V, f = 1 MHz                 | N-Ch2  | -    | 2839    | 3900    |     |  |
| · · · · · ·  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 25 V, f = 1 MHz                 | N-Ch 1 | -    | 331     | 500     | _   |  |
| Output capacitance   | Coss                | $V_{GS} = 0 V$          | V <sub>DS</sub> = 25 V, f = 1 MHz                 | N-Ch2  | -    | 888     | 1250    | pF  |  |
|  |                     | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 25 V, f = 1 MHz                 | N-Ch 1 | -    | 31      | 50      |     |  |
| Reverse transfer capacitance   | C <sub>rss</sub>    | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 25 V, f = 1 MHz                 | N-Ch 2 | -    | 27      | 40      |     |  |
| Total gate charge <sup>c</sup>   |                     | V <sub>GS</sub> = 10 V  | $V_{DS} = 20 \text{ V}, I_{D} = 1 \text{ A}$      | N-Ch 1 | -    | 22      | 33      |     |  |
|  | Qg                  | V <sub>GS</sub> = 10 V  | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1 A      | N-Ch2  | -    | 48.2    | 75      |     |  |
| Oala a a a a a a a a a a   |                     | V <sub>GS</sub> = 10 V  | $V_{DS} = 20 \text{ V}, I_{D} = 1 \text{ A}$      | N-Ch 1 | -    | 3.5     | -       | nC  |  |
| Gate-source charge <sup>c</sup>  | $Q_{gs}$            | V <sub>GS</sub> = 10 V  | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1 A      | N-Ch 2 | -    | 7.1     | -       |     |  |
|  | Q <sub>gd</sub>     | V <sub>GS</sub> = 10 V  | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1 A      | N-Ch 1 | -    | 3.9     | -       |     |  |
| Gate-drain charge c  |                     | V <sub>GS</sub> = 10 V  | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1 A      | N-Ch2  | -    | 8       | -       |     |  |
|  | $R_g$               |                         |   | N-Ch 1 | 1.74 | 3.49    | 5.30    | _   |  |
| Gate resistance  |                     |                         | f = 1 MHz   | N-Ch 2 | 0.55 | 1.10    | 1.65    | Ω   |  |



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| PARAMETER                          | SYMBOL               | TEST CONDITIONS  | MIN.   | TYP. | MAX. | UNIT  |      |  |  |  |
|------------------------------------|----------------------|--|--------|------|------|-------|------|--|--|--|
| Dynamic <sup>b</sup>               |                      |  |        |      |      |       |      |  |  |  |
| Turn-on delay time c               | +                    | $V_{DD}$ = 20 V, $R_L$ = 20 $\Omega$ , $I_D \cong$ 1 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$   | N-Ch 1 | -    | 10   | 20    |      |  |  |  |
| Turn-on delay time                 | t <sub>d(on)</sub>   | $\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_{L} = 20 \Omega, \\ I_{D} &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega \end{aligned}$ | N-Ch 2 | -    | 14   | 25    |      |  |  |  |
| Disa tima C                        | +                    | $V_{DD}$ = 20 V, $R_L$ = 20 $\Omega$ , $I_D \cong$ 1 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$   | N-Ch 1 | -    | 4    | 10    |      |  |  |  |
| Rise time <sup>c</sup>             | t <sub>r</sub> –     | $\begin{aligned} V_{DD} &= 20 \text{ V}, \text{ R}_L = 20 \Omega, \\ I_D &\cong 1 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega \end{aligned}$       | N-Ch 2 | -    | 5    | 10    | no   |  |  |  |
| Turn-off delay time <sup>c</sup>   | +                    | $V_{DD}$ = 20 V, $R_L$ = 20 $\Omega$ , $I_D \cong$ 1 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$   | N-Ch 1 | -    | 24   | 50    | - ns |  |  |  |
| Turn-on delay time                 | t <sub>d(off)</sub>  | $V_{DD}$ = 20 V, $R_L$ = 20 $\Omega$ , $I_D \cong 1$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$   | N-Ch 2 | -    | 35   | 55    |      |  |  |  |
| Fall Aires C                       |                      | $V_{DD}$ = 20 V, $R_L$ = 20 $\Omega$ , $I_D \cong 1$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$   | N-Ch 1 | -    | 25   | 50    |      |  |  |  |
| Fall time <sup>c</sup>             | t <sub>f</sub> –     | $V_{DD} = 20 \text{ V}, R_L = 20 \Omega,$<br>$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$   | N-Ch 2 | -    | 57   | 90    |      |  |  |  |
| Source-Drain Diode Ratings and C   | haracteristic        | s <sup>b</sup>   |        |      | •    |       | ,    |  |  |  |
| Pulsed current a                   | I                    |  | N-Ch 1 | -    | -    | 80    |      |  |  |  |
| ruised current                     | I <sub>SM</sub>      |  | N-Ch 2 | -    | -    | 220   | Α    |  |  |  |
| Forward voltage                    | W                    | $I_F = 6 A, V_{GS} = 0 V$  | N-Ch 1 | -    | 0.77 | 1.2   | V    |  |  |  |
| Forward voitage                    | V <sub>SD</sub>      | $I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$   | N-Ch 2 | -    | 0.76 | 1.2   | 1 °  |  |  |  |
| Body diode reverse recovery time   | +                    | $I_F = 1 A$ , di/dt = 100 A/ $\mu$ s   | N-Ch 1 | -    | 28   | 60    |      |  |  |  |
| Body diode reverse recovery time   | t <sub>rr</sub> —    | $I_F = 1 A$ , di/dt = 100 A/ $\mu$ s   | N-Ch 2 | -    | 39   | 80    | ns   |  |  |  |
| Dady diada wayana wasa sa sa sa    | Q <sub>rr</sub>      | $I_F = 1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$   | N-Ch 1 | -    | 17   | 35    |      |  |  |  |
| Body diode reverse recovery charge | Q <sub>rr</sub>      | $I_F = 1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$   | N-Ch 2 | -    | 46   | 95    | nC   |  |  |  |
| Davage receiver fell time          |                      | $I_F = 1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$   | N-Ch 1 | -    | 14   | -     |      |  |  |  |
| Reverse recovery fall time         | t <sub>a</sub>       | I <sub>F</sub> = 1 A, di/dt = 100 A/μs   | N-Ch 2 | -    | 23   | -     |      |  |  |  |
|                                    | _                    | I <sub>F</sub> = 1 A, di/dt = 100 A/μs   | N-Ch 1 | -    | 14   | -     | ns   |  |  |  |
| Reverse recovery rise time         | t <sub>b</sub>       | I <sub>F</sub> = 1 A, di/dt = 100 A/μs   | N-Ch2  | -    | 16   | -     |      |  |  |  |
| Body diode peak reverse recovery   |                      | I <sub>F</sub> = 1 A, di/dt = 100 A/μs   | N-Ch 1 | -    | -1.1 | -     | Α    |  |  |  |
| current                            | I <sub>RM(REC)</sub> | I <sub>F</sub> = 1 A, di/dt = 100 A/μs   | N-Ch 2 | -    | -2.1 | -   ^ |      |  |  |  |

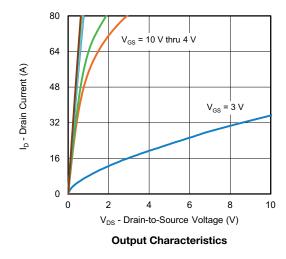
### Notes

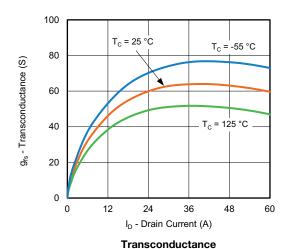
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

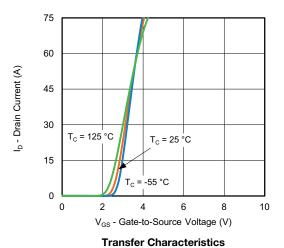
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

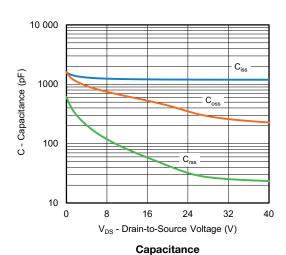


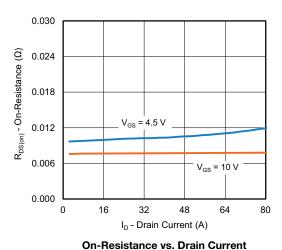
### **N-CHANNEL 1 TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)

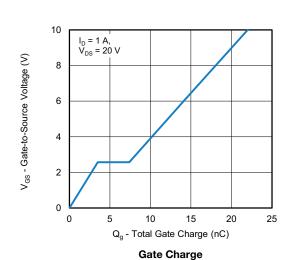






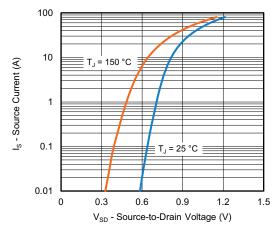




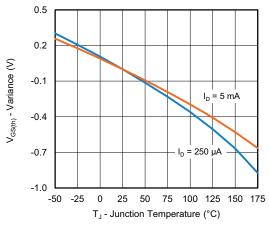




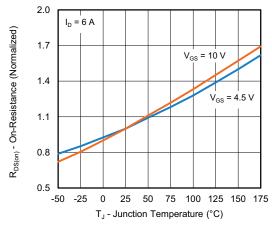
### **N-CHANNEL 1 TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)



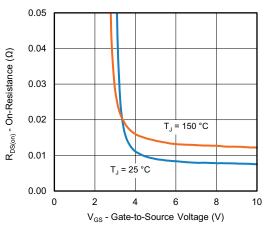
### **Source Drain Diode Forward Voltage**



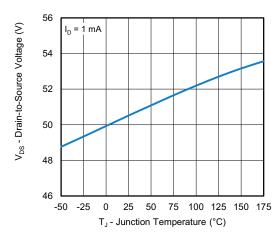
**Threshold Voltage** 



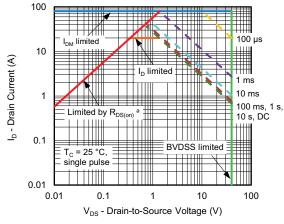
On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



**Drain Source Breakdown vs. Junction Temperature** 



Safe Operating Area

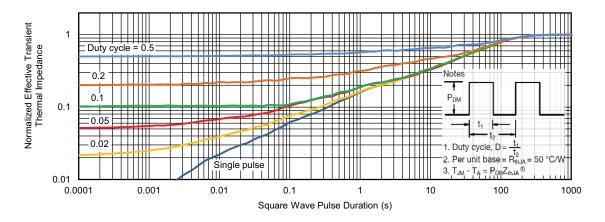
### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

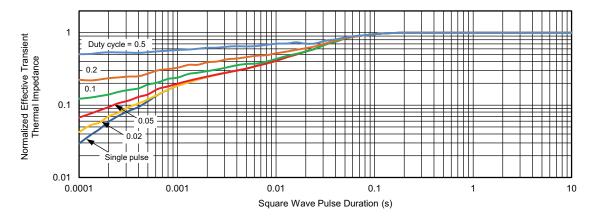
For technical questions, contact: automostecl



### N-CHANNEL 1 TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



### Normalized Thermal Transient Impedance, Junction-to-Ambient



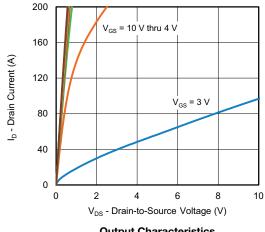
### Normalized Thermal Transient Impedance, Junction-to-Case

### Note

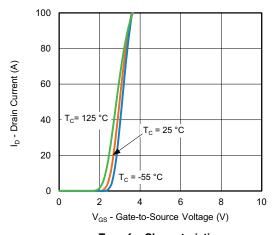
- The characteristics shown in the graph:
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C) is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions



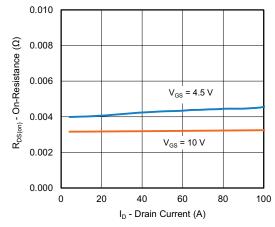
### **N-CHANNEL 2 TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)



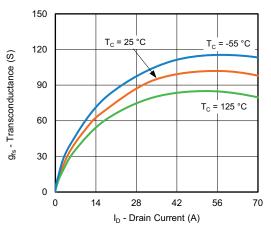




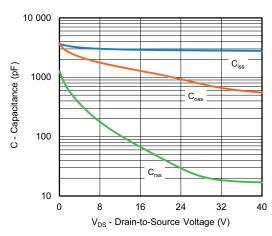




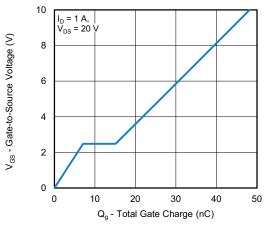
On-Resistance vs. Drain Current



Transconductance



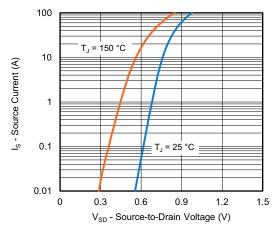
Capacitance



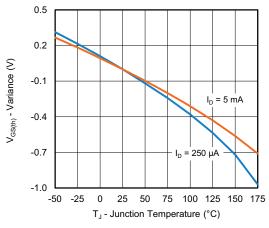
**Gate Charge** 



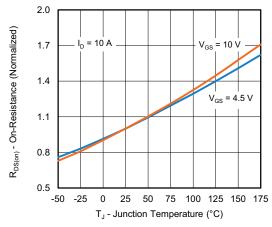
### **N-CHANNEL 2 TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)



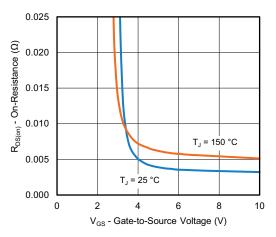
### **Source Drain Diode Forward Voltage**



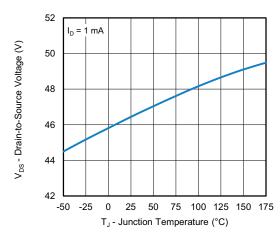
**Threshold Voltage** 



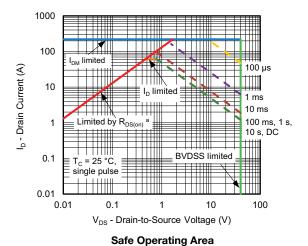
On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



**Drain Source Breakdown vs. Junction Temperature** 

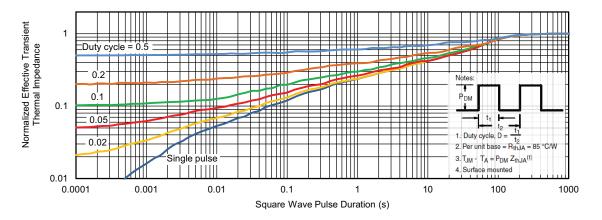


### Note

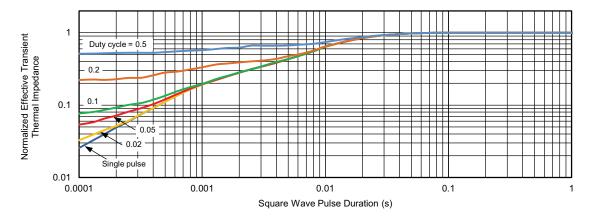
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



### N-CHANNEL 2 TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



### Normalized Thermal Transient Impedance, Junction-to-Ambient



### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

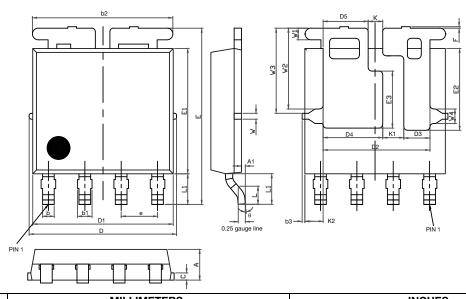
- The characteristics shown in the graph:
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C) is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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# PowerPAK® SO-8L Assymetric Case Outline



| DIM. |      | MILLIMETERS |      | INCHES |       |       |  |
|------|------|-------------|------|--------|-------|-------|--|
| DIM. | MIN. | NOM.        | MAX. | MIN.   | NOM.  | MAX.  |  |
| А    | 1.00 | 1.07        | 1.14 | 0.039  | 0.042 | 0.045 |  |
| A1   | 0.00 | 0.06        | 0.13 | 0.000  | 0.003 | 0.005 |  |
| b    | 0.33 | 0.41        | 0.48 | 0.013  | 0.016 | 0.019 |  |
| b1   | 0.44 | 0.51        | 0.58 | 0.017  | 0.020 | 0.023 |  |
| b2   | 4.80 | 4.90        | 5.00 | 0.189  | 0.193 | 0.197 |  |
| b3   | 0.04 | 0.12        | 0.20 | 0.002  | 0.005 | 0.008 |  |
| С    | 0.20 | 0.25        | 0.30 | 0.008  | 0.010 | 0.012 |  |
| D    | 5.00 | 5.13        | 5.25 | 0.197  | 0.202 | 0.207 |  |
| D1   | 4.80 | 4.90        | 5.00 | 0.189  | 0.193 | 0.197 |  |
| D2   | 3.63 | 3.73        | 3.83 | 0.143  | 0.147 | 0.151 |  |
| D3   | 0.81 | 0.91        | 1.01 | 0.032  | 0.036 | 0.040 |  |
| D4   | 1.98 | 2.08        | 2.18 | 0.078  | 0.082 | 0.086 |  |
| D5   | 1.47 | 1.57        | 1.67 | 0.058  | 0.062 | 0.066 |  |
| е    | 1.20 | 1.27        | 1.34 | 0.047  | 0.050 | 0.053 |  |
| Е    | 6.05 | 6.15        | 6.25 | 0.238  | 0.242 | 0.246 |  |
| E1   | 4.27 | 4.37        | 4.47 | 0.168  | 0.172 | 0.176 |  |
| E2   | 2.75 | 2.85        | 2.95 | 0.108  | 0.112 | 0.116 |  |
| E3   | 1.89 | 1.99        | 2.09 | 0.074  | 0.078 | 0.082 |  |
| F    | 0.05 | 0.12        | 0.19 | 0.002  | 0.005 | 0.007 |  |
| L    | 0.62 | 0.72        | 0.82 | 0.024  | 0.028 | 0.032 |  |
| L1   | 0.92 | 1.07        | 1.22 | 0.036  | 0.042 | 0.048 |  |
| K    | 0.41 | 0.51        | 0.61 | 0.016  | 0.020 | 0.024 |  |
| K1   | 0.64 | 0.74        | 0.84 | 0.025  | 0.029 | 0.033 |  |
| K2   | 0.54 | 0.64        | 0.74 | 0.021  | 0.025 | 0.029 |  |
| W    | 0.13 | 0.23        | 0.33 | 0.005  | 0.009 | 0.013 |  |
| W1   | 0.31 | 0.41        | 0.51 | 0.012  | 0.016 | 0.020 |  |
| W2   | 2.72 | 2.82        | 2.92 | 0.107  | 0.111 | 0.115 |  |
| W3   | 2.86 | 2.96        | 3.06 | 0.113  | 0.117 | 0.120 |  |
| W4   | 0.41 | 0.51        | 0.61 | 0.016  | 0.020 | 0.024 |  |
| θ    | 5°   | 10°         | 12°  | 5°     | 10°   | 12°   |  |

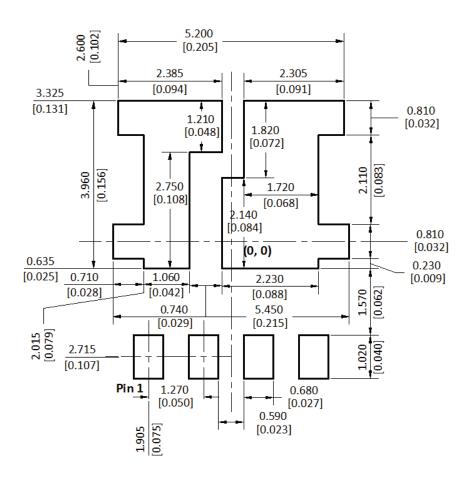
DWG: 6009

#### Note

• Millimeters will govern



### RECOMMENDED MINIMUM PADs FOR PowerPAK® SO-8L DUAL ASYMMETRIC



Recommended Minimum Pads Dimensions in mm [inches]



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Vishay

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